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# MAC15M, MAC15N

# Triacs

## Silicon Bidirectional Thyristors

Designed for high performance full-wave AC control applications where high noise immunity and high commutating di/dt are required.

### Features

- Blocking Voltage to 800 Volts
- On-State Current Rating of 15 Amperes RMS at 80°C
- Uniform Gate Trigger Currents in Three Modes
- High Immunity to dv/dt – 250 V/μs minimum at 125°C
- Minimizes Snubber Networks for Protection
- Industry Standard TO–220 Package
- High Commutating di/dt – 9.0 A/ms minimum at 125°C
- Operational in Three Quadrants, Q1, Q2, and Q3
- These Devices are Pb–Free and are RoHS Compliant*

**MAXIMUM RATINGS** ($T_J$ = 25°C unless otherwise noted)

| Rating | Symbol | Value | Unit |
|---|---|---|---|
| Peak Repetitive Off–State Voltage (Note 1) (–40 to 125°C, Sine Wave, 50 to 60 Hz, Gate Open) MAC15M MAC15N | $V_{DRM}$, $V_{RRM}$ | 600 800 | V |
| On–State RMS Current (Full Cycle Sine Wave, 60 Hz, $T_C$ = 80°C) | $I_{T(RMS)}$ | 15 | A |
| Peak Non-repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, $T_J$ = 125°C) | $I_{TSM}$ | 150 | A |
| Circuit Fusing Consideration (t = 8.3 ms) | $I^2t$ | 93 | $A^2s$ |
| Peak Gate Power (Pulse Width ≤ 1.0 μs, $T_C$ = 80°C) | $P_{GM}$ | 20 | W |
| Average Gate Power (t = 8.3 ms, $T_C$ = 80°C) | $P_{G(AV)}$ | 0.5 | W |
| Operating Junction Temperature Range | $T_J$ | –40 to +125 | °C |
| Storage Temperature Range | $T_{stg}$ | –40 to +150 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. $V_{DRM}$ and $V_{RRM}$ for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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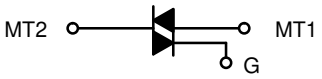
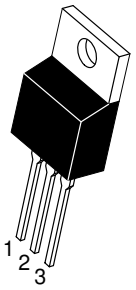
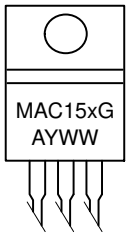
**TRIACS**
**15 AMPERES RMS**
**600 thru 800 VOLTS**




**TO–220**
**CASE 221A**
**STYLE 4**

**MARKING DIAGRAM**




x = M or N
A = Assembly Location
Y = Year
WW = Work Week
G = Pb–Free Package

| PIN ASSIGNMENT | |
|---|---|
| 1 | Main Terminal 1 |
| 2 | Main Terminal 2 |
| 3 | Gate |
| 4 | Main Terminal 2 |

**ORDERING INFORMATION**

| Device | Package | Shipping |
|---|---|---|
| MAC15MG | TO–220 (Pb–Free) | 50 Units / Rail |
| MAC15NG | TO–220 (Pb–Free) | 50 Units / Rail |

## THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|---|---|---|---|
| Thermal Resistance, Junction−to−Case<br>Junction−to−Ambient | $R_{\theta JC}$<br>$R_{\theta JA}$ | 2.0<br>62.5 | °C/W |
| Maximum Lead Temperature for Soldering Purposes 1/8″ from Case for 10 Seconds | $T_L$ | 260 | °C |

## ELECTRICAL CHARACTERISTICS ($T_J$ = 25°C unless otherwise noted; Electricals apply in both directions)

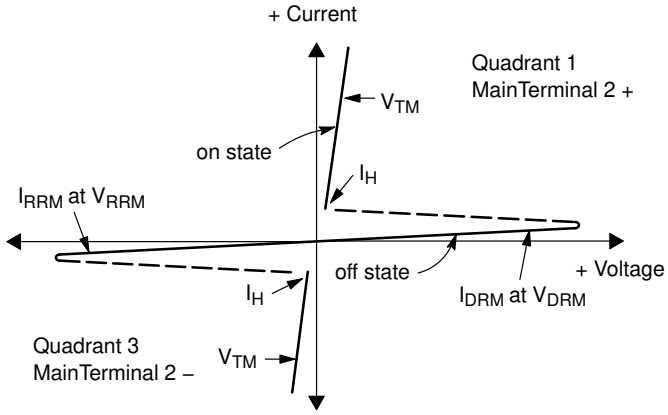
| Characteristic | Symbol | Min | Typ | Max | Unit |
|---|---|---|---|---|---|
| **OFF CHARACTERISTICS** | | | | | |
| Peak Repetitive Blocking Current<br>($V_D$ = Rated $V_{DRM}$, $V_{RRM}$; Gate Open) $T_J$ = 25°C<br>$T_J$ = 125°C | $I_{DRM}$,<br>$I_{RRM}$ | <br>–<br>– | <br>–<br>– | <br>0.01<br>2.0 | mA |
| **ON CHARACTERISTICS** | | | | | |
| Peak On-State Voltage (Note 2)<br>($I_{TM}$ = ±21 A Peak) | $V_{TM}$ | – | 1.2 | 1.6 | V |
| Gate Trigger Current (Continuous DC) ($V_D$ = 12 V, $R_L$ = 100 Ω)<br>MT2(+), G(+)<br>MT2(+), G(–)<br>MT2(–), G(–) | $I_{GT}$ | <br>5.0<br>5.0<br>5.0 | <br>13<br>16<br>18 | <br>35<br>35<br>35 | mA |
| Hold Current<br>($V_D$ = 12 Vdc, Gate Open, Initiating Current = ±150 mA) | $I_H$ | – | 20 | 40 | mA |
| Latching Current ($V_D$ = 24 V, $I_G$ = 35 mA)<br>MT2(+), G(+)<br>MT2(+), G(–)<br>MT2(–), G(–) | $I_L$ | <br>–<br>–<br>– | <br>33<br>36<br>33 | <br>50<br>80<br>50 | mA |
| Gate Trigger Voltage ($V_D$ = 12 V, $R_L$ = 100 Ω)<br>MT2(+), G(+)<br>MT2(+), G(–)<br>MT2(–), G(–) | $V_{GT}$ | <br>0.5<br>0.5<br>0.5 | <br>0.75<br>0.72<br>0.82 | <br>1.5<br>1.5<br>1.5 | V |
| **DYNAMIC CHARACTERISTICS** | | | | | |
| Rate of Change of Commutating Current; See Figure 10.<br>($V_D$ = 400 V, $I_{TM}$ = 6.0 A, Commutating dv/dt = 24 V/μs, $C_L$ = 10 μF<br>Gate Open, $T_J$ = 125°C, f = 250 Hz, No Snubber) $L_L$ = 40 mH | $(di/dt)_c$ | 9.0 | – | – | A/ms |
| Critical Rate of Rise of Off-State Voltage<br>($V_D$ = Rated $V_{DRM}$, Exponential Waveform, Gate Open, $T_J$ = 125°C) | dv/dt | 250 | – | – | V/μs |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

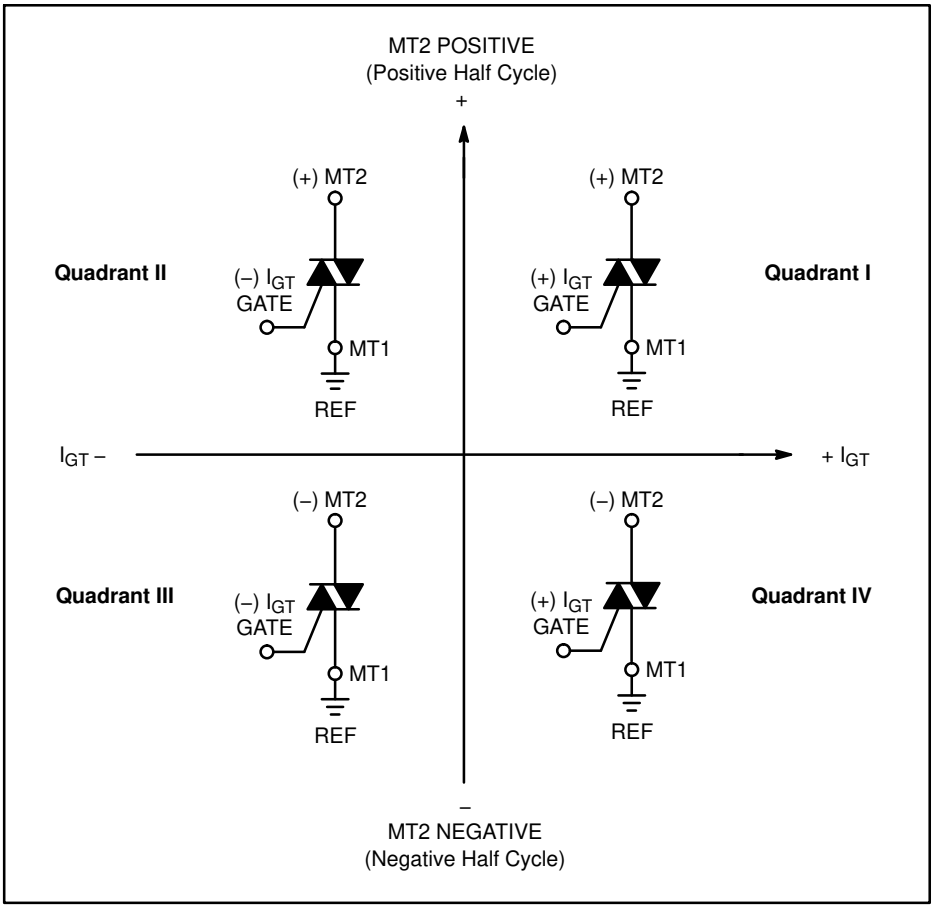
2. Pulse Test: Pulse Width ≤ 2.0 ms, Duty Cycle ≤ 2%.

## Voltage Current Characteristic of Triacs (Bidirectional Device)

| Symbol | Parameter |
|---|---|
| $V_{DRM}$ | Peak Repetitive Forward Off State Voltage |
| $I_{DRM}$ | Peak Forward Blocking Current |
| $V_{RRM}$ | Peak Repetitive Reverse Off State Voltage |
| $I_{RRM}$ | Peak Reverse Blocking Current |
| $V_{TM}$ | Maximum On State Voltage |
| $I_H$ | Holding Current |




## Quadrant Definitions for a Triac




All polarities are referenced to MT1.
With in−phase signals (using standard AC lines) quadrants I and III are used.

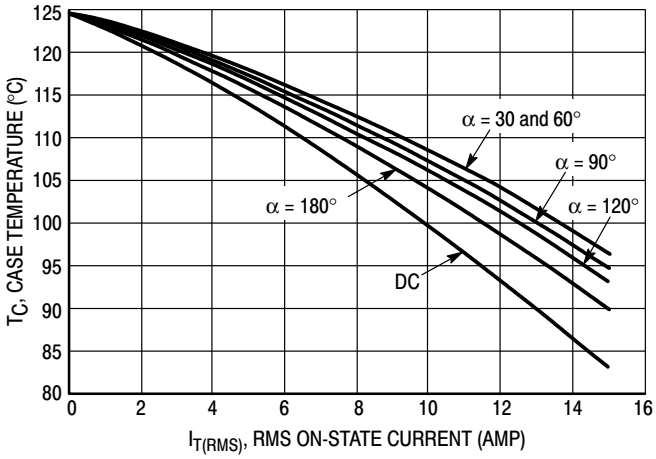



**Figure 1. RMS Current Derating**

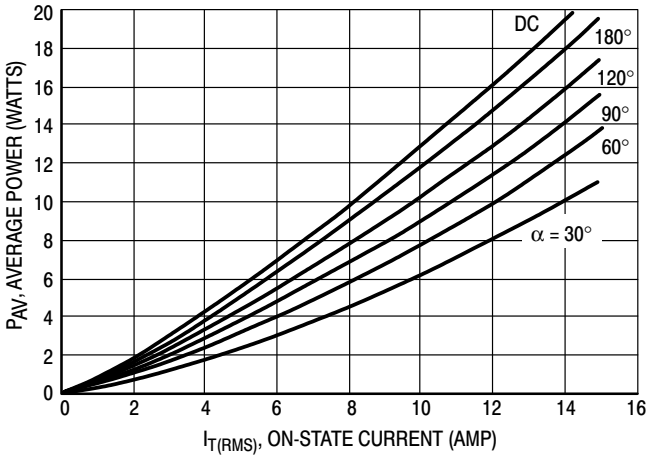



**Figure 2. On–State Power Dissipation**

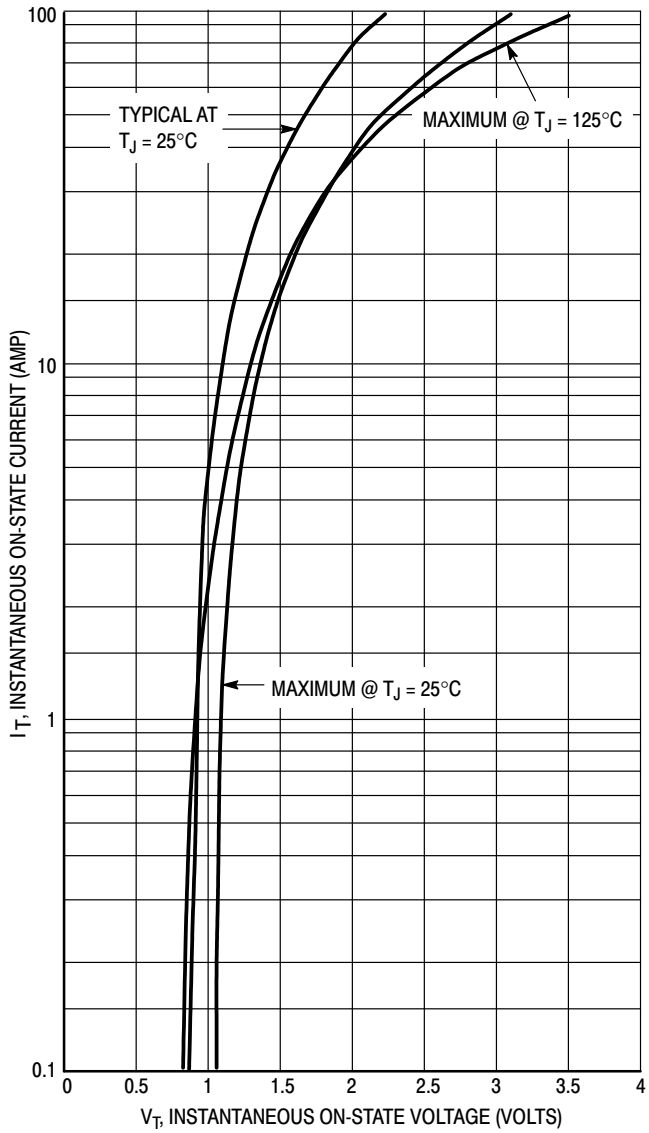



**Figure 3. On–State Characteristics**

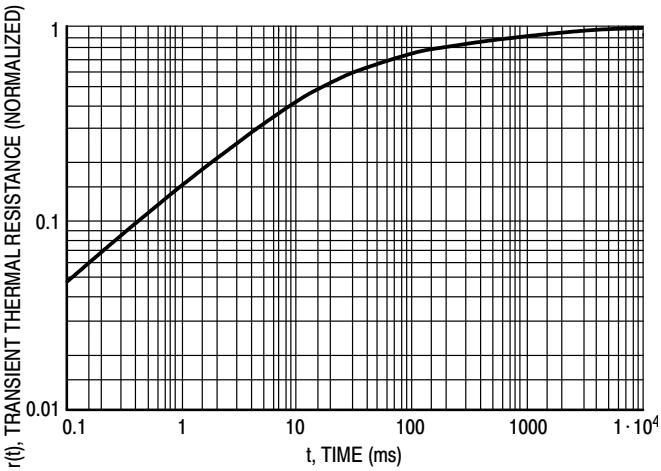



**Figure 4. Transient Thermal Response**

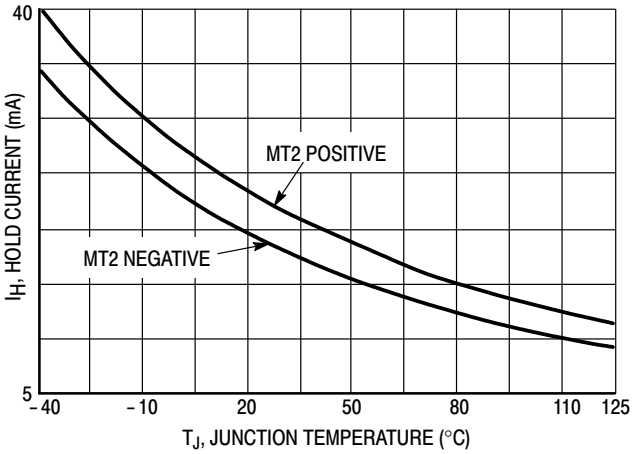



**Figure 5. Hold Current Variation**

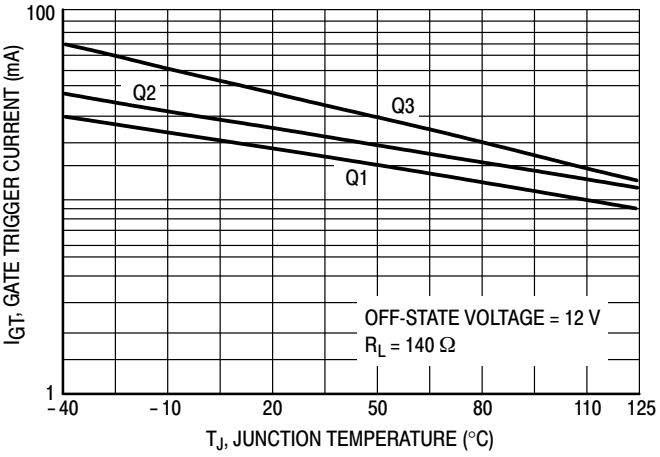



**Figure 6. Typical Holding Current versus Junction Temperature**

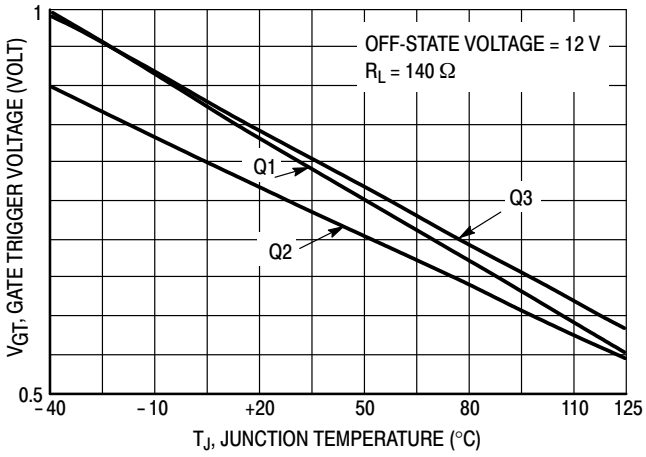



**Figure 7. Gate Trigger Voltage versus Junction Temperature**

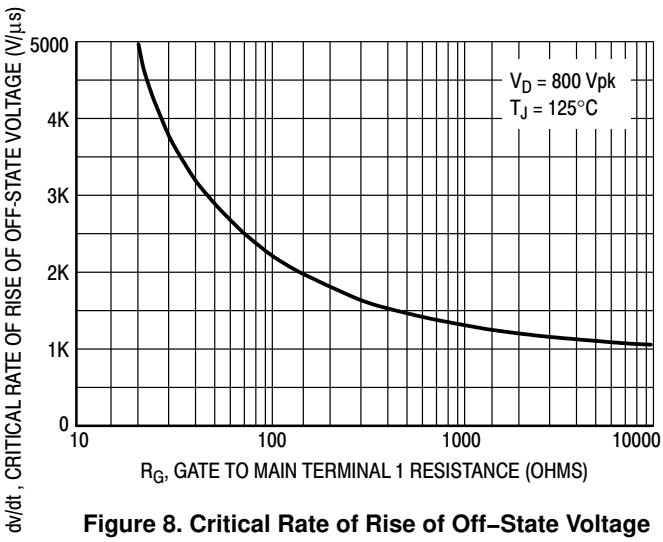



**Figure 8. Critical Rate of Rise of Off−State Voltage (Exponential)**

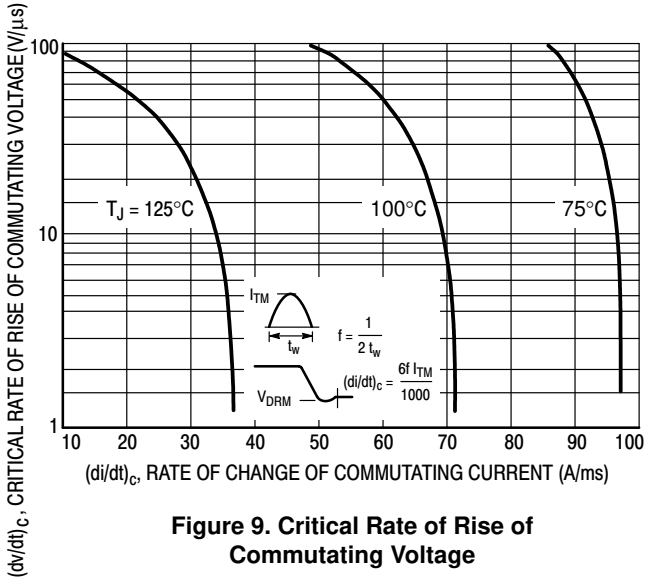
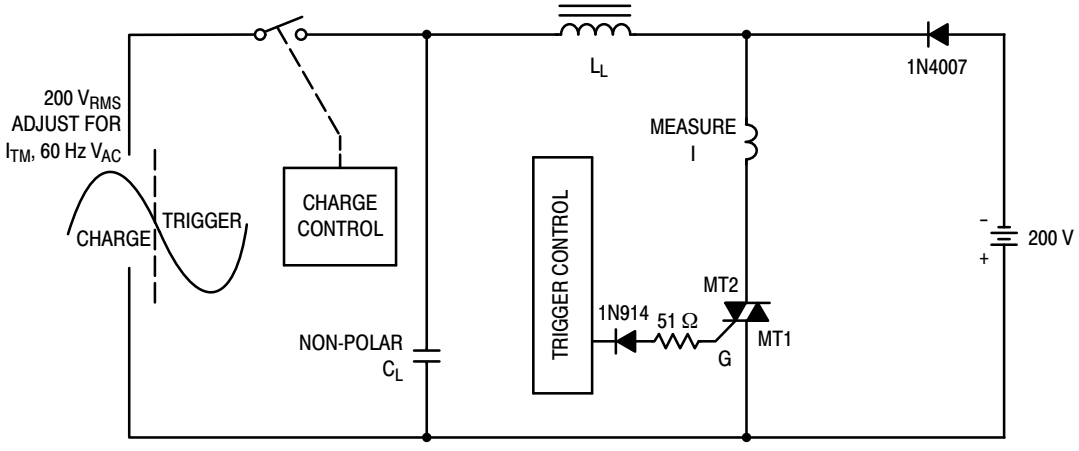



**Figure 9. Critical Rate of Rise of Commutating Voltage**

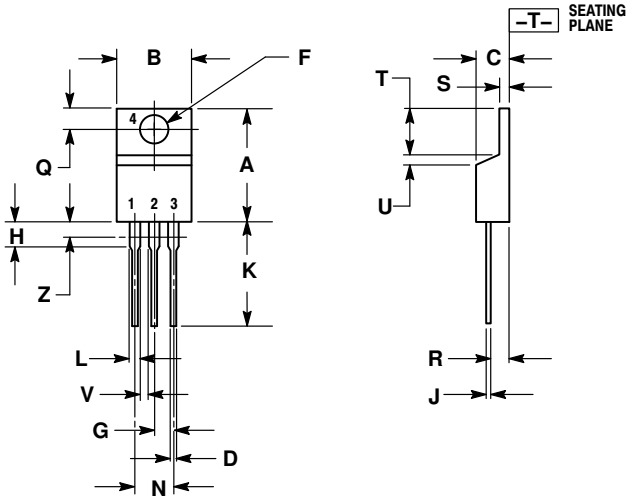



Note: Component values are for verification of rated $(di/dt)_c$. See AN1048 for additional information.

**Figure 10. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Current $(di/dt)_c$**

## PACKAGE DIMENSIONS

**TO–220**
CASE 221A–09
ISSUE AH




NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

| | INCHES | | MILLIMETERS | |
|---|---|---|---|---|
| DIM | MIN | MAX | MIN | MAX |
| A | 0.570 | 0.620 | 14.48 | 15.75 |
| B | 0.380 | 0.415 | 9.66 | 10.53 |
| C | 0.160 | 0.190 | 4.07 | 4.83 |
| D | 0.025 | 0.038 | 0.64 | 0.96 |
| F | 0.142 | 0.161 | 3.61 | 4.09 |
| G | 0.095 | 0.105 | 2.42 | 2.66 |
| H | 0.110 | 0.161 | 2.80 | 4.10 |
| J | 0.014 | 0.024 | 0.36 | 0.61 |
| K | 0.500 | 0.562 | 12.70 | 14.27 |
| L | 0.045 | 0.060 | 1.15 | 1.52 |
| N | 0.190 | 0.210 | 4.83 | 5.33 |
| Q | 0.100 | 0.120 | 2.54 | 3.04 |
| R | 0.080 | 0.110 | 2.04 | 2.79 |
| S | 0.045 | 0.055 | 1.15 | 1.39 |
| T | 0.235 | 0.255 | 5.97 | 6.47 |
| U | 0.000 | 0.050 | 0.00 | 1.27 |
| V | 0.045 | --- | 1.15 | --- |
| Z | --- | 0.080 | --- | 2.04 |

STYLE 4:
PIN 1. MAIN TERMINAL 1
2. MAIN TERMINAL 2
3. GATE
4. MAIN TERMINAL 2



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**MAC15M/D**